The Effect of Zirconium Doping on Solution-Processed Indium Oxide Thin Films Measured by a Novel Nondestructive Testing Method (Microwave Photoconductivity Decay)

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Received: 4 June 2019; Accepted: 4 July 2019; Published: 5 July 2019

Abstract: Solution-processed indium oxide is an ideal transparent semiconductor material with wide band gap. Zirconium is an element characterized by a strong binding ability to oxygen which can inhibit the formation of oxygen vacancies and reduce the surface defect state. In this paper, zirconium doped indium oxide (InₓZrᵧO) thin films were prepared by the solution method, with indium oxide being doped with zirconium in order to tune the relative number of oxygen vacancies. The influence of the Zr doping concentration and the post-annealed temperature on the properties of the InₓZrᵧO thin films was investigated. The results show that the doping process improves the crystallinity and relative density of the obtained films. A novel nondestructive method named microwave photoconductivity decay (µ-PCD) was used to evaluate the quality of InₓZrᵧO thin films by simply measuring their response under laser irradiation. The relative number of oxygen vacancies and the minority carrier concentration achieved minimum values at 10 at.% Zr doping concentration. Furthermore, InₓZrᵧO thin films with optimal properties from an electrical point of view were obtained at 10 at.% Zr doping concentration, annealed at 400 °C. Characterized by an average transmittance above 90% in the visible range, the obtained InₓZrᵧO thin films can be used as active layer materials in the fabrication of high-performance thin film transistor (TFT) devices.

Keywords: solution process; indium oxide; zirconium doping; oxygen vacancies

1. Introduction

Nowadays, active matrix liquid crystal displays (AMLCD) and active matrix organic light-emitting diodes (AMOLED) have occupied the mainstream position in the display field [1–4]. As the important component of flat-panel displays (FPDs), thin film transistors (TFTs) have attracted widespread attention. Metal oxide thin film transistors (MOS-TFTs) have been widely studied due to their advantages of high mobility, high optical transmittance, low process temperature, and low processing cost [5–9].

The MOS-TFT device prepared by Magnetron sputtering presents excellent electrical characteristics, but it has shortcomings such as relatively complex fabrication process, high cost and RF radiation damage. Solution-processed MOS films exhibit many advantages such as low cost, and the prepared films have excellent uniformity and high component purity [1,10–14]. The solution-processing method
mainly includes dip coating, spraying, spin coating, printing, and so on. Spin coating is one of the most used methods. It has the advantages of uniform film making, low cost, simplicity, and high throughput. However, solution-processed films still suffer from high porosity and poor quality, which have a great influence on the properties of thin films [13–16].

Indium oxide (In$_2$O$_3$) films have high electron mobility, high carrier density, and excellent optical transmittance compared with other oxide semiconductors [17,18], making them an ideal material for transparent thin film transistors [19]. In order to obtain high-quality In$_2$O$_3$ films, other elements are added, such as InSnO (ISO) [20–22], InZnSnO (IZTO) [23–26], InGaZnO (IGZO) [27–30], etc. The Zr element has a strong binding capacity to oxygen (Zr–O: 776 KJ/mol), higher than that of the In element to oxygen (In–O: 348 KJ/mol), which can inhibit the formation of oxygen vacancies. Moreover, the radius of Zr$^{4+}$ (0.72 Å) is close to the radius of In$^{3+}$ (0.79 Å), so the addition will form a stable lattice structure [31,32].

Microwave photoconductivity decay ($\mu$-PCD) is a noncontact and nondestructive technology with low cost and short time [33–35]. Information regarding the defect state density can be obtained by the microwave reflectivity of the photo-carrier trapping and recombination, this being an important parameter for the evaluation of the quality of the semiconductor thin films.

In this research, zirconium doped indium oxide (In$_x$Zr$_y$O) films were prepared on UV-treated substrates. Atomic force microscopy (AFM), thermogravimetry-differential scanning calorimetry (TG-DSC), X-ray reflectivity (XRR), X-ray diffraction (XRD), X-ray photoelectron spectroscopy (XPS), and microwave photoconductivity decay ($\mu$-PCD) were used to evaluate the physical and chemical properties of In$_x$Zr$_y$O films. The influence of the Zr doping concentration and the post-annealed temperature on the properties of In$_x$Zr$_y$O films was discussed.

2. Materials and Methods

The precursor solutions were prepared by dissolving indium nitrate [In(NO$_3$)$_3$] and zirconium nitrate pentahydrate [Zr(NO$_3$)$_4$·5H$_2$O] at different ratios (Zr:In = 0 at.%, 5 at.%, 10 at.%, 15 at.%) in 2-methoxyethanol. These solutions were stirred vigorously for 24 h and then were aged for 48 h under ambient conditions. The surface tension and contact angle of these solutions were measured by an Attension Theta Lite (Biolin Scientific, Gothenburg, Sweden, TL200). Thermogravimetric differential scanning calorimetry (TG-DSC) was used to measure the thermal behavior of precursor solutions with a heating rate of 10 $^\circ$C/min (from room temperature to 600 $^\circ$C).

The substrates were cleaned by UV/ozone at 25 $^\circ$C for 2 min. The In$_x$Zr$_y$O thin films were fabricated by spin coating on the glass substrate at 5000 rpm for 40 s and then post-annealed at varying temperatures (250, 300, 350, and 400 $^\circ$C) for 1 hour under air. The transmissivity of In$_x$Zr$_y$O thin films was investigated with a UV-VIS spectrophotometer (Shimadzu UV-3600, Kyoto, Japan). X-ray reflectivity (XRR) (EMPYREAN, PANalytical, Almelo, The Netherlands) was used to investigate the thicknesses and densities of In$_x$Zr$_y$O films, and the crystallization of In$_x$Zr$_y$O thin films with different Zr concentrations was measured by X-ray diffraction (XRD) (EMPYREAN, PANalytical). Atomic force microscopy (AFM) (BY3000, Being Nano-Instruments, Guangzhou, China) was used to investigate the surface morphology of In$_x$Zr$_y$O thin films. X-ray photoelectron spectroscopy (XPS) (Thermo Fisher Scientific, Waltham, MA, USA) analysis was carried out to investigate the chemical composition of the In$_x$Zr$_y$O thin films with the carbon 1s peak (284.8 eV) as a calibration reference. The decay curve and peak mean value of the In$_x$Zr$_y$O thin films were measured by a microwave photoconductivity decay ($\mu$-PCD) measurement system (KOBELCO, LTA-1620 SP, Kobe, Japan).

3. Results and Discussion

The surface tension of the In$_x$Zr$_y$O solution is shown in Figure 1a. When the droplet volume was 7.85 $\mu$L, the solution exhibited a surface tension of 30.82 mN/m. In order to improve the surface hydrophilicity of the glass substrate and then improve the surface topography of the coated In$_x$Zr$_y$O thin film, UV treatment was carried out on the substrate before spin coating. UV treatment was used
to remove the surface contaminants and increase the number of the surface dangling bonds, which improved the uniformity of the thin films. As shown in Figure 1b,c, the contact angle formed by the precursor droplet was smaller after the UV treatment of the glass substrate. As shown in Figure 1d,e, the deposited film showed poor uniformity due to the small surface energy of the substrate without UV treatment, while the UV-treated one was more uniform and had better morphology.

![Figure 1](image1.png)

**Figure 1.** (a) The surface tension of In$_x$Zr$_y$O precursor solution. (b) Contact angle of precursor solution on the glass substrate without UV treatment. (c) Contact angle of precursor solution on the glass substrate with UV treatment. (d) Top view of In$_x$Zr$_y$O film on glass substrate without UV treatment. (e) Top view of In$_x$Zr$_y$O film on glass substrate with UV treatment.

The thermogravimetry-differential scanning calorimetry (TG-DSC) of the In$_x$Zr$_y$O solution with different Zr contents (Zr:In = 0, 5, 10, and 15 at.%) was measured, and the curves with different Zr contents were roughly the same. Figure 2 shows the TG-DSC curves of the In$_x$Zr$_y$O solution (Zr:In = 15 at.%). The DSC curve shows an endothermic peak at about 130 °C, which is related to the boiling point of the solvent. The decline of the TG curve also illustrates this point. It was determined that the annealing temperature of In$_x$Zr$_y$O films should be higher than 130 °C. The exothermic peak located at about 150 °C can be explained by the bonding of metal and oxygen, and the metal oxide begins to form a grid structure. The exothermic peak located at 300–370 °C can be attributed to the crystallization of In$_2$O$_3$.

![Figure 2](image2.png)

**Figure 2.** Thermal behavior of In$_x$Zr$_y$O precursor solution (Zr:In = 15 at.%) analyzed by thermogravimetry-differential scanning calorimetry (TG-DSC).

The density, thickness, and uniformity of the films are closely related to the annealing temperature and the doping concentration of zirconium. The annealing temperatures were set as 250, 300, 350, and 400 °C, and the doping concentrations of zirconium were set as 0, 5, 10, and 15 at.%. The thickness
and density of the thin films were measured with XRR, as shown in Table 1. The relative density \( q \) is calculated by the relation:

\[
q = \frac{\rho}{\rho_1 - \rho_2},
\]

where \( \rho \) is the density measured by XRR, \( \rho_1 \) is the bulk density, and \( \rho_2 \) is the density of air in this case.

<table>
<thead>
<tr>
<th>Zr Doping Concentration (at.%)</th>
<th>Temperature (°C)</th>
<th>Thickness (nm)</th>
<th>Density (ρ) (g/cm³)</th>
<th>Bulk Density (ρ₁) (g/cm³)</th>
<th>Relative Density (q)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>250</td>
<td>8.065</td>
<td>5.574</td>
<td>7.179</td>
<td>0.776</td>
</tr>
<tr>
<td>5</td>
<td>300</td>
<td>8.130</td>
<td>6.051</td>
<td>7.113</td>
<td>0.851</td>
</tr>
<tr>
<td>10</td>
<td>350</td>
<td>8.525</td>
<td>5.930</td>
<td>7.046</td>
<td>0.842</td>
</tr>
<tr>
<td>15</td>
<td>400</td>
<td>9.244</td>
<td>5.972</td>
<td>6.980</td>
<td>0.856</td>
</tr>
<tr>
<td>15</td>
<td>250</td>
<td>12.910</td>
<td>5.187</td>
<td></td>
<td>0.743</td>
</tr>
<tr>
<td></td>
<td>300</td>
<td>11.642</td>
<td>5.650</td>
<td></td>
<td>0.809</td>
</tr>
<tr>
<td></td>
<td>350</td>
<td>9.504</td>
<td>6.093</td>
<td></td>
<td>0.873</td>
</tr>
<tr>
<td></td>
<td>400</td>
<td>9.244</td>
<td>5.972</td>
<td></td>
<td>0.856</td>
</tr>
</tbody>
</table>

The influence of the zirconium doping concentration and annealing temperature on the thin film thickness and density was analyzed. It can be seen from Figure 3a that the thickness and the relative density increased with the increase of the zirconium doping concentration. It can be observed from Figure 3b that the thickness of the thin film decreased with the increase of the annealing temperature. The relative density of thin film increased to a peak value around 350 °C, then decreased, which can be associated with high temperature removing the impurities in thin film.

Figure 4 shows the XRD spectra of In₂O₃ films with different Zr contents (Zr:In = 0, 5, 10, and 15 at.%) at the annealing temperature of 400 °C. As can be seen from the figure, for pure In₂O₃, there were corresponding peaks at (222), (440), and (622), and the intensity of the (222) diffraction peak was the highest. With doping with Zr, it was found that the (222) peak shifted to the right, indicating the gradual substitution of In³⁺ by Zr⁴⁺. With the increase of Zr doping concentration, the diffraction peaks at (222), (440), and (622) became higher, indicating an increased transformation from amorphous phase into crystalline phase, which is due to the strong binding ability of Zr to oxygen (Zr–O: 776 KJ/mol). Zr doping is beneficial to the oxidation and crystallization of In₂O₃ films annealed at 400 °C.
According to the results of XRR and XRD, large relative density of the film and crystallization occurred at 400 °C. For the semiconductor layer, the appearance of the crystal state is beneficial for improving electrical properties. Therefore, the investigation data at 400 °C are displayed when discussing the following experiment results.

To investigate the influence of the different zirconium doping concentrations (Zr:In = 0, 5, 10, and 15 at.%) at 400 °C on the surface morphology of In$_x$Zr$_y$O thin films, atomic force microscopy (AFM) was used. The scanning area of the images was 3.0 $\times$ 3.0 $\mu$m$^2$. Figure 5 shows AFM images of In$_x$Zr$_y$O thin films with different Zr concentrations, and it can be seen that all samples show a relatively smooth morphology without cracks.

Root mean square ($S_q$) is used to describe the surface morphology, which is the standard deviation of the height in a testing area. The surface roughness of the thin film might increase when adding zirconium atoms into the precursor solution. However, because the In$_2$O$_3$ films are doped with a trace of Zr, the surface roughness of the thin film is only slightly affected. The $S_q$ of a pure In$_2$O$_3$ film is 0.136 nm, and the value changed to 0.121 and 0.137 nm for the films of Zr:In = 5 and 10 at.%, respectively. When the Zr doping concentration was 15 at.%, the $S_q$ value of the thin film (0.157 nm) was the highest.

Figure 4. X-ray diffraction (XRD) patterns of the In$_x$Zr$_y$O films with different Zr contents (Zr:In = 0, 5, 10, and 15 at.%) annealed at 400 °C.

Figure 5. Atomic force microscopy (AFM) 3D images (3.0 $\times$ 3.0 $\mu$m$^2$) of In$_x$Zr$_y$O thin films at 400 °C with different Zr doping concentrations, (a–d): Zr:In = 0, 5, 10, and 15 at.%, respectively.
X-ray photoelectron spectra (XPS) were used to confirm the chemical structure and composition of the \( \text{In}_2\text{O}_3 \) thin film doped with different concentrations of Zr annealed at 400 °C. The presence of In, O, C, and Zr elements can all be confirmed by the XPS spectra shown in Figure 6a, also, impurity elements such as N were not detected, which indicates that the residual solvent was basically removed. According to the spectral peak information, the doping ratio of zirconium in four different samples was basically in line with expectations.

Figure 6b–d shows the peak separation result of O 1s, and it can be generally divided into two different near-Gaussian subpeaks. The major peak at around 529.8 eV is attributed to the bonding of oxygen and metal ions (M–O), and the peak located at around 531.5 eV is assigned to oxygen atoms near the oxygen vacancy. The relative quantity of oxygen vacancies under the four doping ratios are shown in Table 2.

**Table 2.** The relative quantity of oxygen vacancies varied with the Zr doping concentrations.

<table>
<thead>
<tr>
<th>Zr Doping Concentration (at.%)</th>
<th>Relative Quantity of Oxygen Vacancies (%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>41.78</td>
</tr>
<tr>
<td>5</td>
<td>30.83</td>
</tr>
<tr>
<td>10</td>
<td>26.09</td>
</tr>
<tr>
<td>15</td>
<td>31.48</td>
</tr>
</tbody>
</table>

Further, the influence of the annealing temperature and the zirconium doping concentration on the quality and properties of \( \text{In}_x\text{Zr}_y\text{O} \) active layer films was investigated by the microwave photoconductivity decay (\( \mu \)-PCD) method. Samples manufactured under different annealing temperatures were respectively tested, and it was found that the \( \text{In}_x\text{Zr}_y\text{O} \) thin film manufactured at 400 °C showed optimal properties. Table 3 shows the properties of \( \text{In}_2\text{O}_3 \) thin film with different doping concentrations of zirconium tested by \( \mu \)-PCD.
Table 3. Properties of In$_2$O$_3$ thin film with different doping concentrations of zirconium tested by μ-PCD.

<table>
<thead>
<tr>
<th>Zr Doping Concentration (at.%)</th>
<th>Peak Mean (mV)</th>
<th>D Value</th>
<th>$\tau_1$ (µs)</th>
<th>$\tau_2$ (µs)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0</td>
<td>104.7</td>
<td>0.3702</td>
<td>0.0593</td>
<td>0.4207</td>
</tr>
<tr>
<td>5</td>
<td>95.4</td>
<td>0.3925</td>
<td>0.0562</td>
<td>0.6472</td>
</tr>
<tr>
<td>10</td>
<td>87.0</td>
<td>0.5263</td>
<td>0.0586</td>
<td>0.4034</td>
</tr>
<tr>
<td>15</td>
<td>99.7</td>
<td>0.5012</td>
<td>0.3761</td>
<td>1.1260</td>
</tr>
</tbody>
</table>

Figure 7a–d shows the μ-PCD mapping scan of the In$_2$O$_3$ thin film with different Zr doping ratios (Zr:In = 0, 5, 10, and 15 at.%) annealed at 400 °C. The reflectivity peak signal of μ-PCD correlated with the shallow local defect state concentration of the oxide and varied with the composite rate of photo-generated carriers, so it has important significance for us to study the mobility and concentration of carriers. The overall homogeneity of carriers in In$_x$Zr$_y$O films obtained by spin coating was good. However, the small centripetal force in the middle of the substrate may be a major reason that leads to less carrier distribution in the spin coating process. Meanwhile, the average value of the carrier peak value measured was larger, indicating that the In$_x$Zr$_y$O films had good quality and electrical properties.

Figure 7. The result of microwave photoconductivity decay (μ-PCD) mapping scan of In$_2$O$_3$ thin films when the Zr doping ratio was (a) 0 at.%, (b) 5 at.%, (c) 10 at.%, and (d) 15 at.%. (e) μ-PCD decay curves.
As can be seen from Figure 8a, with the increase of the doping concentration of zirconium, the peak reflectivity signal first gradually decreased. When the doping concentration increased to 10 at.\%, the peak value reached the minimum, and then increased. Along with the increase of the zirconium doping ratio, the peak value decreased first and then increased mainly depending on the following two effects: (1) The difference of electron negativity between Zr (1.4) and O (3.5) is larger than the difference between In (1.7) and O, hence, the combination ability of Zr with O is stronger. So, doping with Zr will more effectively inhibit the production of oxygen vacancies, leading to the decrease of carrier concentration. However, such inhibition will reach a saturation point with an increasing concentration of Zr. It can be seen from Table 2 that the relative quantity of oxygen vacancies first decreased with the increase of doping concentration, and then increased again when the doping concentration reached 15 at.\%. This leads to the carrier concentration decreasing first and then increasing with the Zr doping concentration in the film increasing from 0 to 15 at.\%. (2) The main quantum number of zirconium is large. The 2p orbital of the oxygen ion is small, while the ns orbital of zirconium has a high propagation speed in space. This increases the probability of the overlapping of ns orbitals of adjacent zirconium ions, forming a wider conduction band and improving the mobility of electrons. Under the influence of these two aspects, the peak value of the minority carrier measured by \( \mu \)-PCD showed the above variation to the rule. Additionally, with the increase of the Zr doping concentration, the uniformity of the carriers improved, which can be seen from Figure 7.

![Figure 8](image_url)

**Figure 8.** (a) Peak and D value changes with the Zr doping concentrations under 400 °C. (b) \( \log(1/e) \) and \( \log(1/e^2) \) changes with the Zr doping concentrations under 400 °C.

Another important measurement parameter in \( \mu \)-PCD is the D value, which reflects the situation of trapping and the recombination center [35]. A high D value indicates that the shallow localized state density of carrier trapping or the release center in the middle band gap region of the film is small, and the device has better stability. With the increase of the doping concentration of zirconium, the D value showed an increasing trend, indicating that the small doping of zirconium reduced the density of the defect state. It is related to the higher chemical bond energy of the combination of zirconium and oxygen.

The lifetime of carriers in the photoconductor is mainly related to fast decay time (\( \tau_1 \)) and slow decay time (\( \tau_2 \)), the variation of fast decay time and slow decay time at different zirconium doping ratios is shown in Figures 7c and 8b. Among them, fast decay time is related to the carrier recombination processes of the deep localized states [33]. The longer carrier lifetime is related to the carrier being captured in the defect states for some time and then released. So, as the zirconium doping ratio increases, the density of the deep localized defect states increases. Slow decay time is related to the defect of the shallow localized states concentration. As the zirconium doping ratio increases, the defect of the shallow localized states concentration also increases.

Based on these results it can be concluded that the relative number of oxygen vacancies and the minority carrier concentration decrease with the increase of the Zr doping concentration up to 10 at.\%. Hence, the strongest inhibition effect on the generation of oxygen vacancies (\( V_o = 26.09\% \)) is achieved at this doping concentration for In\(_2\)Zr\(_x\)O thin films annealed at 400 °C.
Figure 9 reveals that the \( \text{In}_x\text{Zr}_y\text{O} \) thin films spin coated on the glass substrate annealed at 400 °C presented a transmittance over 93% in the wavelength range of visible light. The results show that zirconium doping did not affect the transparency of \( \text{In}_2\text{O}_3 \) films, indicating that the \( \text{In}_x\text{Zr}_y\text{O} \) active layer can be applied to transparent devices.

Figure 9. Transmittance of different doping ratio films changes with the wavelength under 400 °C.

4. Conclusions

In summary, we prepared \( \text{In}_x\text{Zr}_y\text{O} \) films by the solution method on UV-treated substrates. \( \mu \)-PCD was used to evaluate the quality of the \( \text{In}_x\text{Zr}_y\text{O} \) thin films by analyzing the response of the thin films under laser irradiation as a noncontact and nondestructive technique. The results show that Zr doping makes the film less defective, gives longer carrier life, and improves the relative density of films. The number of oxygen vacancies reaches the minimum value, \( V_o = 26.09\% \), in the case of \( \text{In}_x\text{Zr}_y\text{O} \) films with 10 at.\% Zr doping concentration, annealed at 400 °C. These features and the good transmittance in the visible domain recommend the prepared \( \text{In}_x\text{Zr}_y\text{O} \) films as active layer materials for the preparation of high-performance TFT devices.


Funding: This work was supported by the National Natural Science Foundation of China (No. 51771074), the Guangdong Science and Technology Project (No. 2016B090907001), the 2019 Guangdong University Student Science and Technology Innovation Special Fund (“Climbing Plan” Special Fund) (Nos. pdjh2019a0028 and pdjh2019b0041), the National College Students’ Innovation and Entrepreneurship Training Program (No. 201910561005), the South China University of Technology 100 Step Ladder Climbing Plan Research Project (No. j2tw201902475), and the Fundamental Research Funds for the Central Universities.

Conflicts of Interest: The authors declare no conflict of interest.

References


